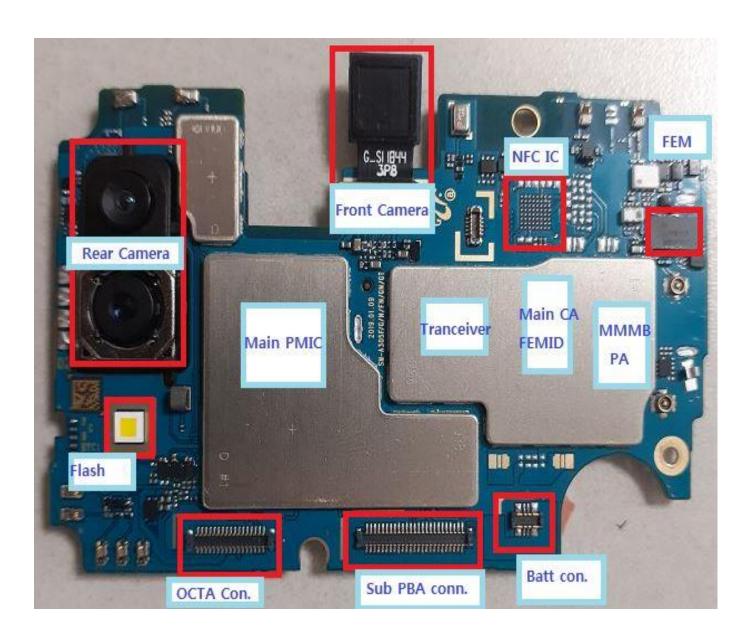
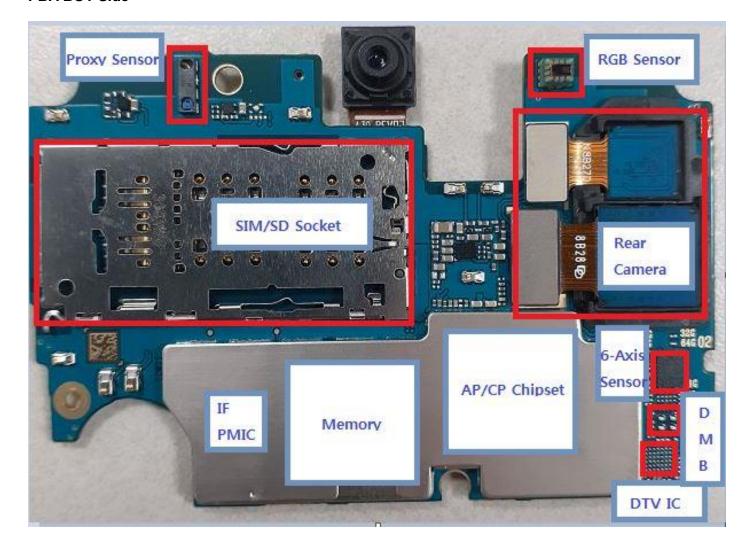
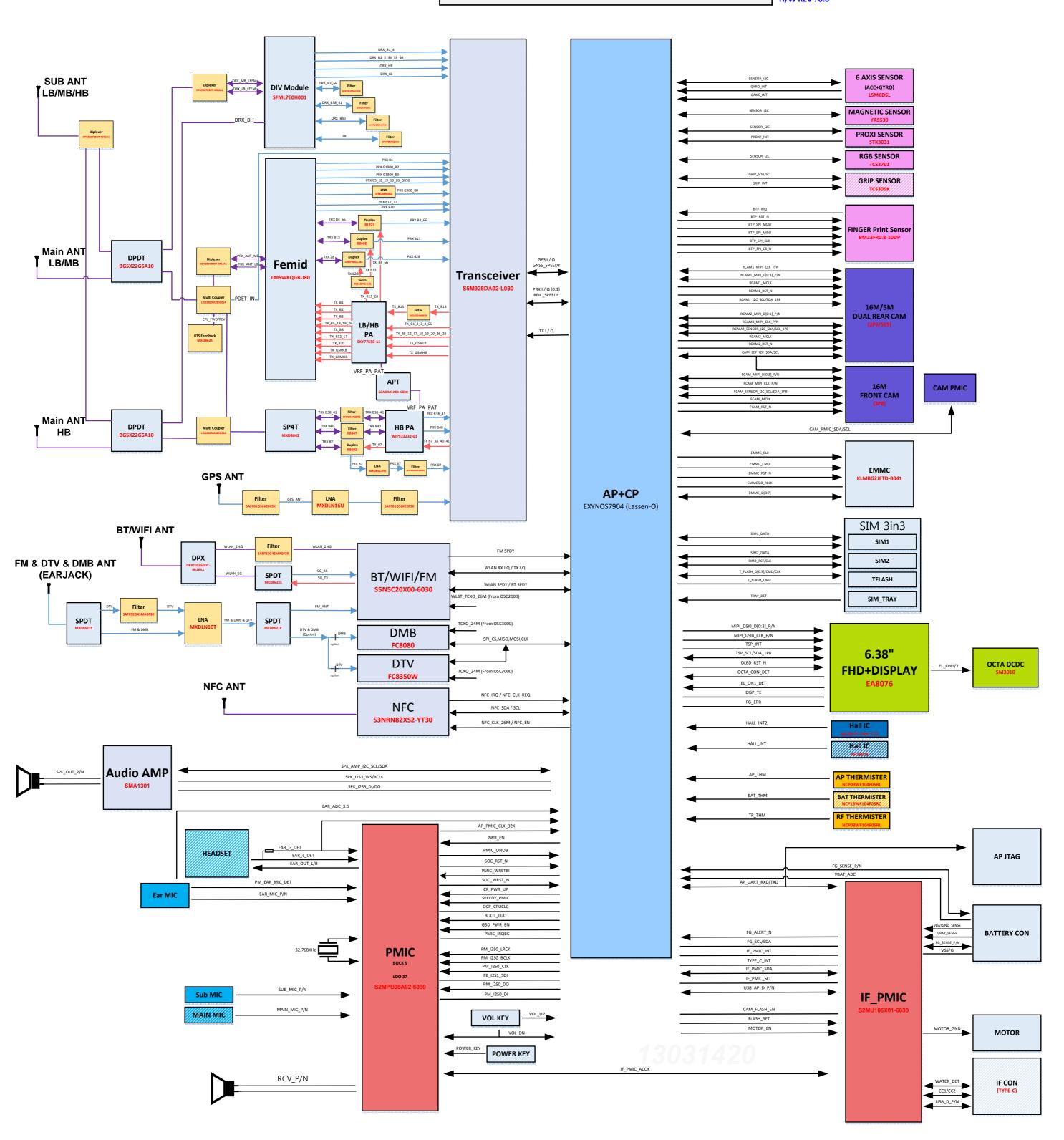
8-1. 부품 배치

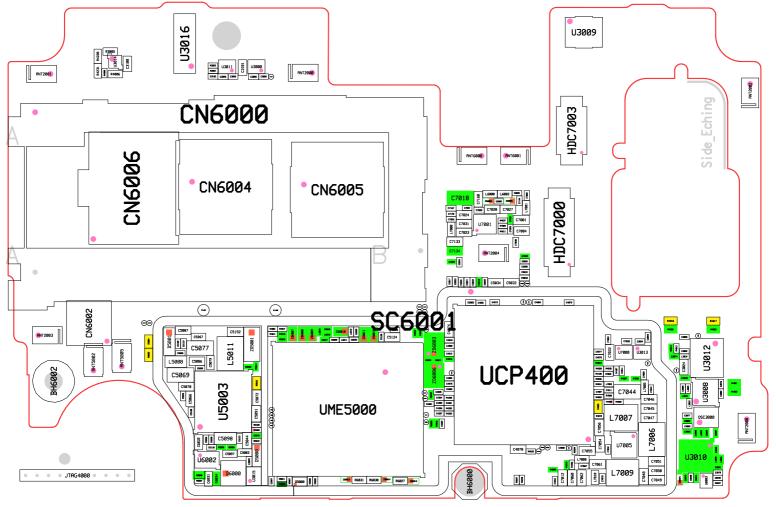
PBA TOP Side

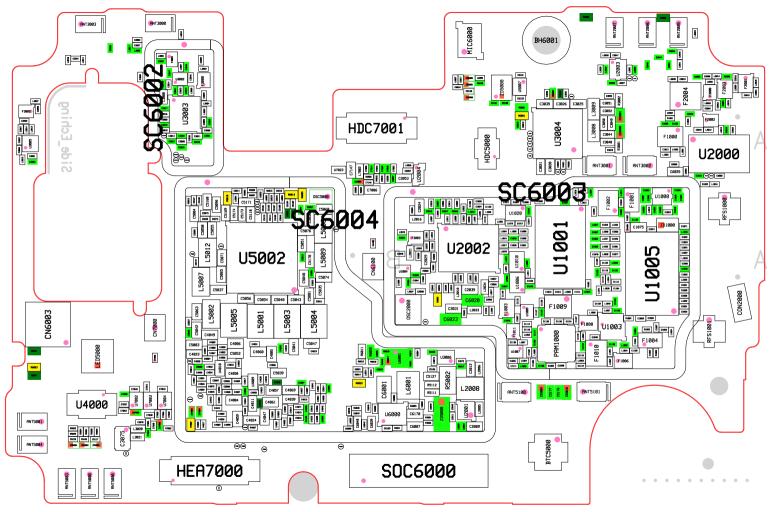


PBA BOT Side

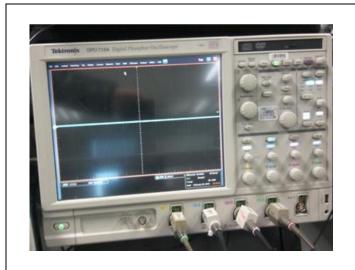








8-3. Flow chart of Troubleshooting.





Oscilloscope

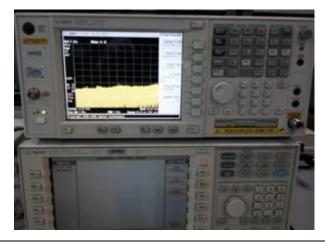
Digital Multimeter





Power Supply

+ driver, ESD Safe Tweezer

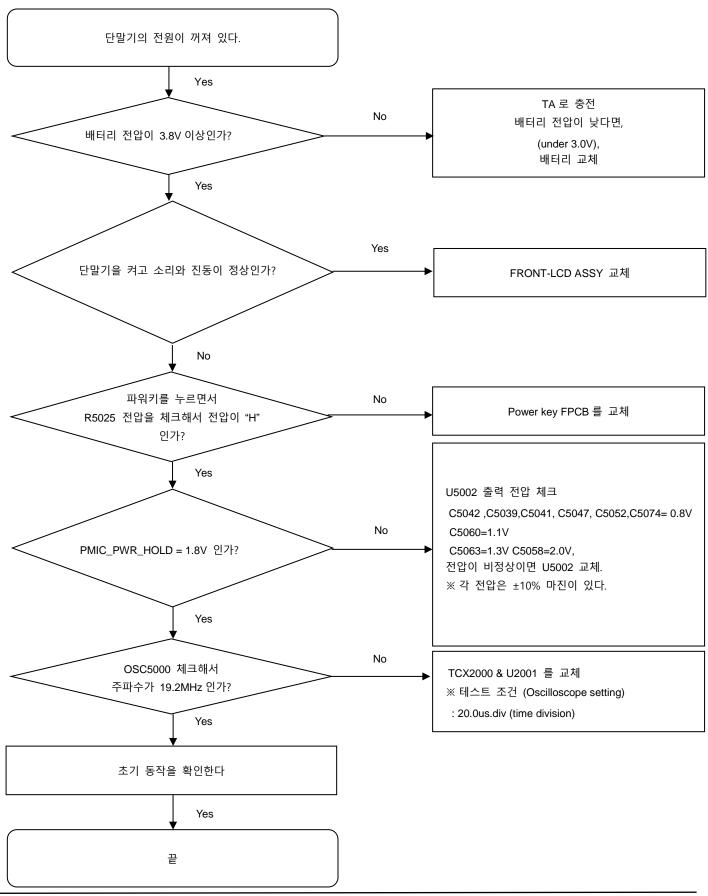




8960 & Spectrum Analyzer

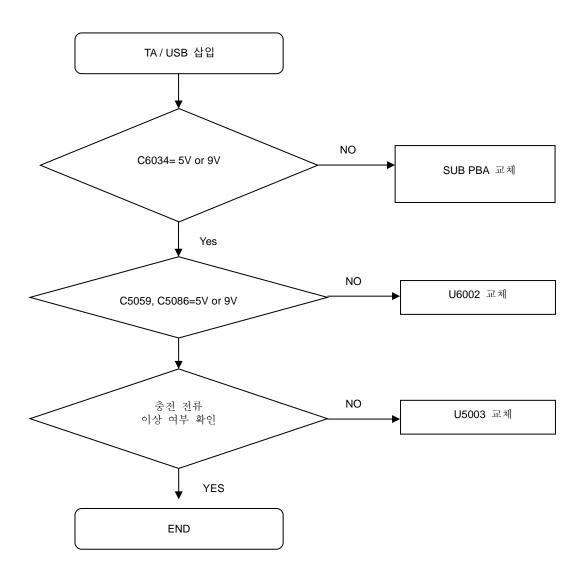
Soldering iron

8-4-1. Power on

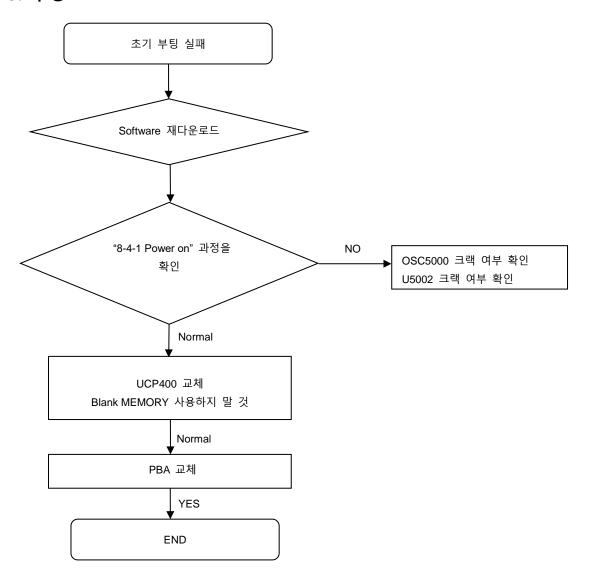


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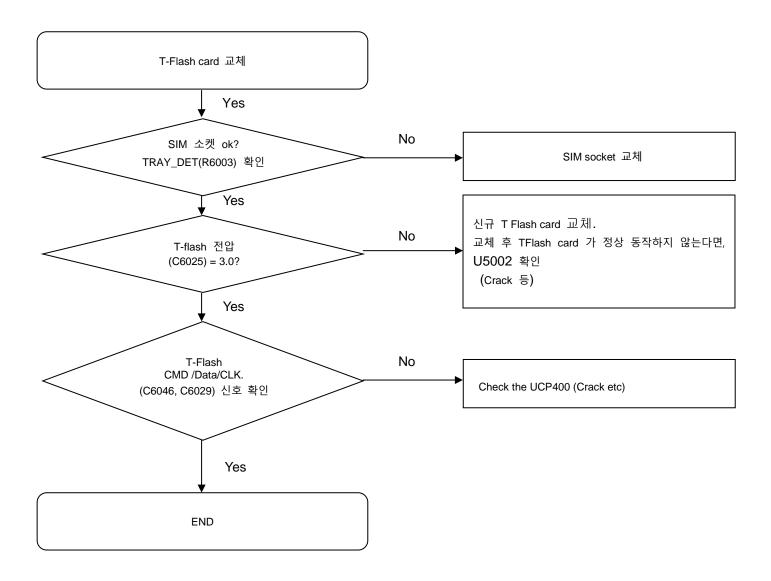
8-4-2. 충전 Part



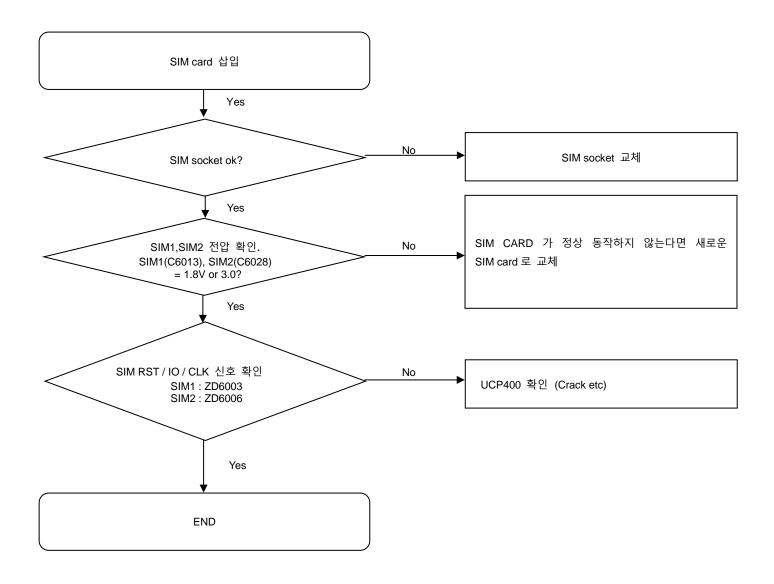
8-4-3. 부팅



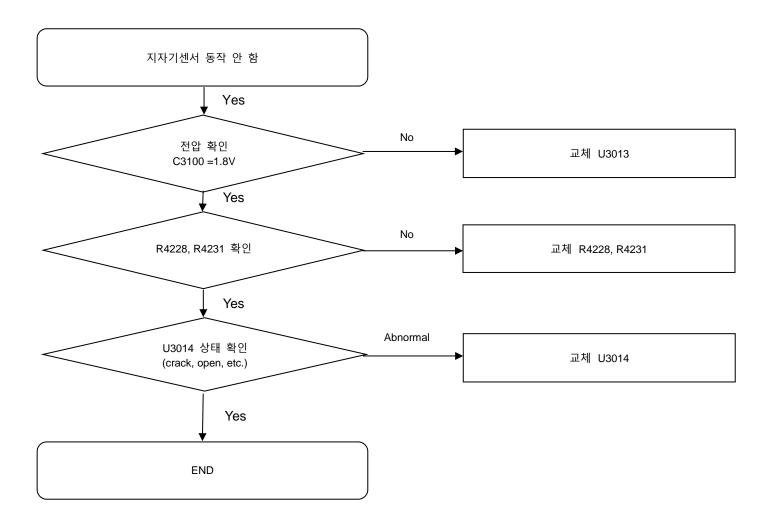
8-4-4. T-Flash Part



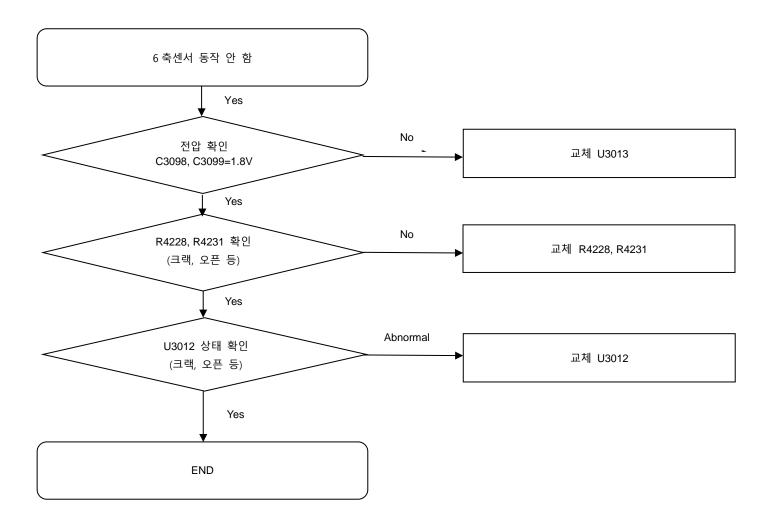
8-4-5. SIM PART



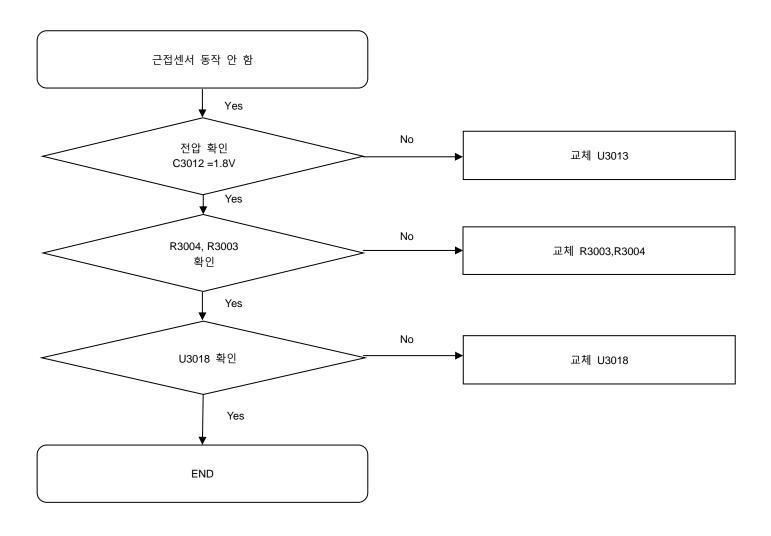
8-4-6-1. 지자기 Sensor



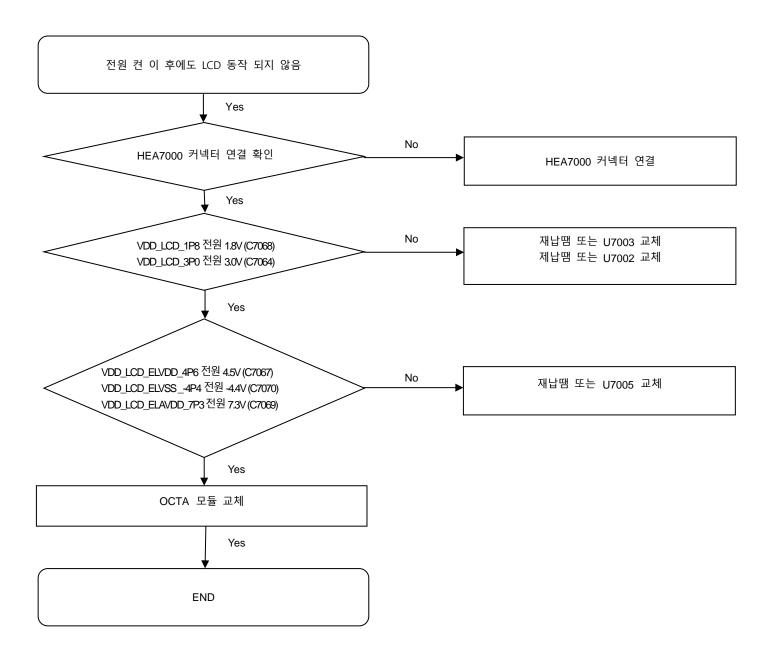
8-4-6-2. 6 축 Sensor



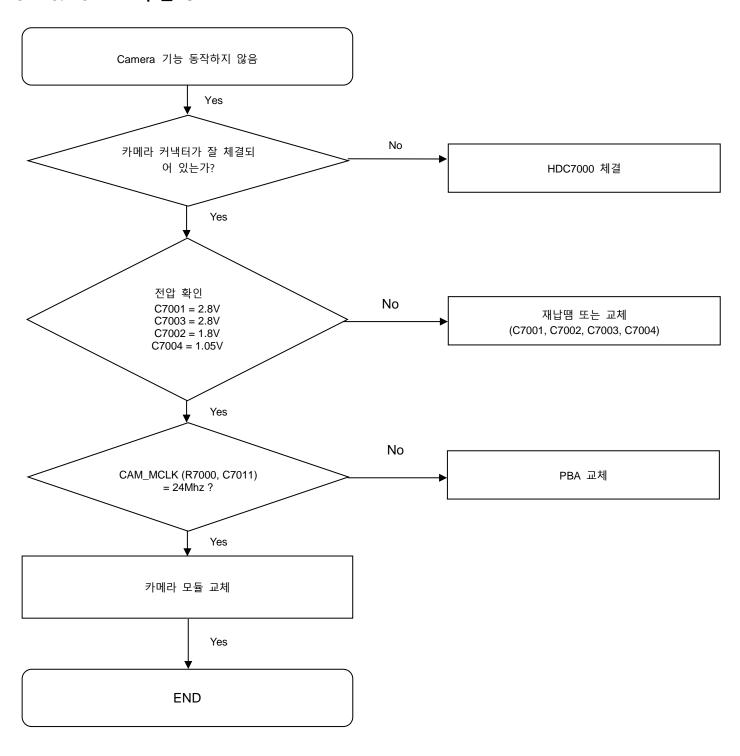
8-4-6-3. 근접 sensor



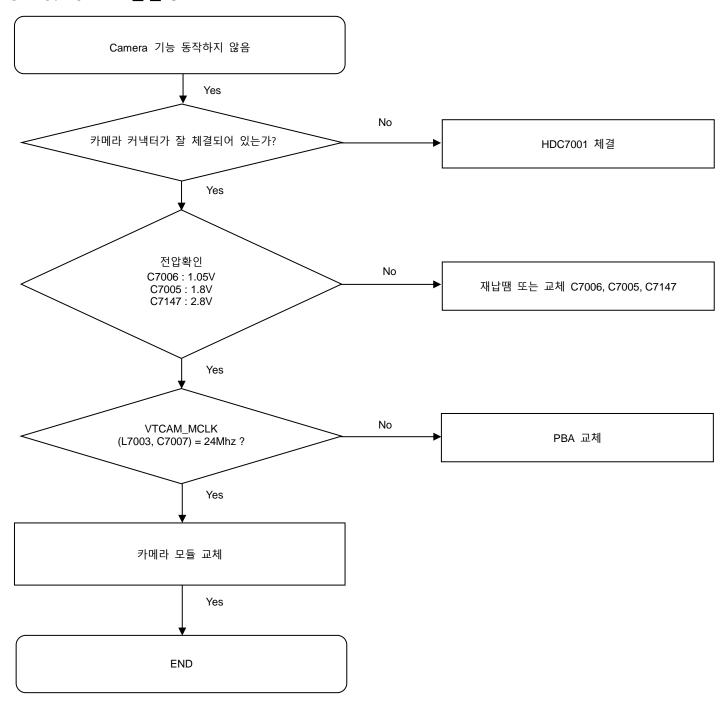
8-4-7. OCTA



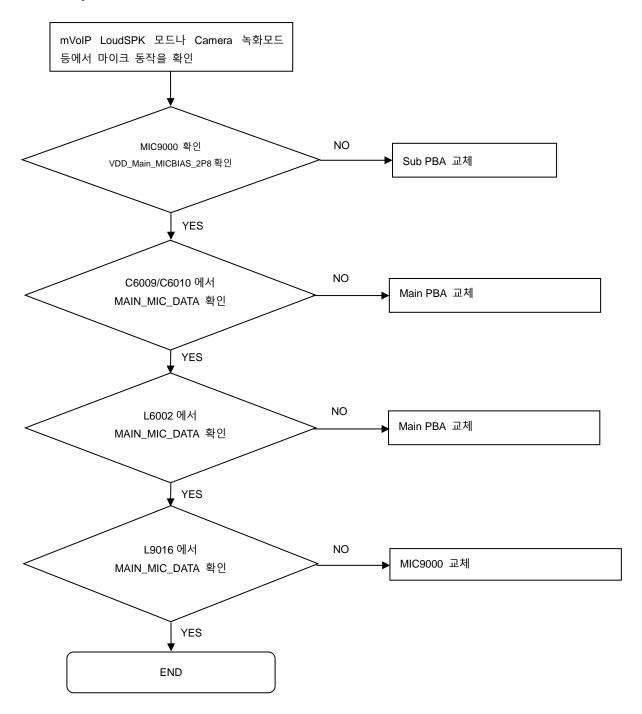
8-4-8. 16M AF 후면 CAMERA



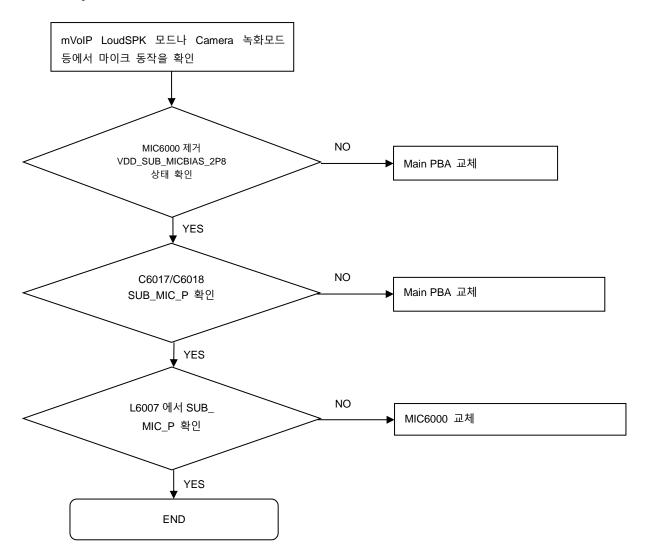
8-4-9. 16M FF 전면 CAMERA



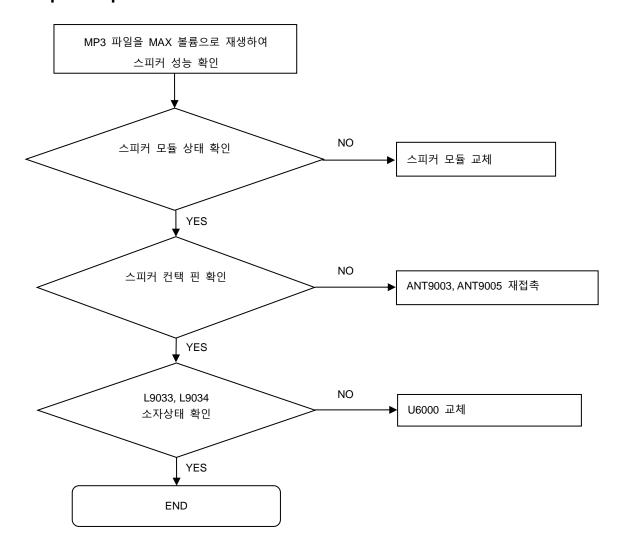
8-4-10. Microphone Part - Main MIC



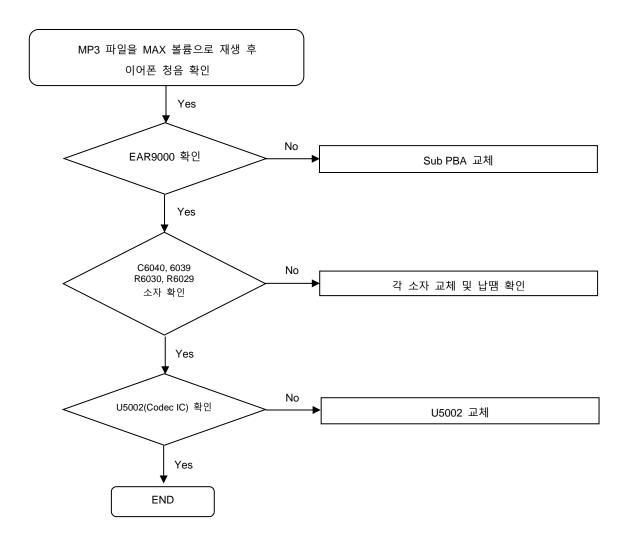
8-4-11. Microphone Part – SUB MIC



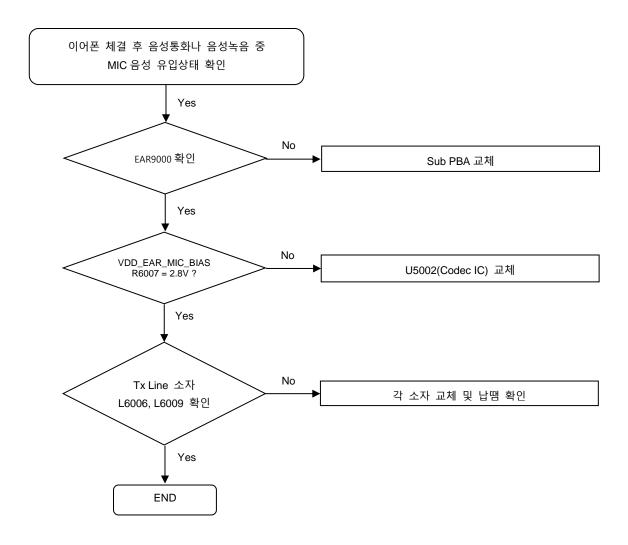
8-4-12. Speaker part



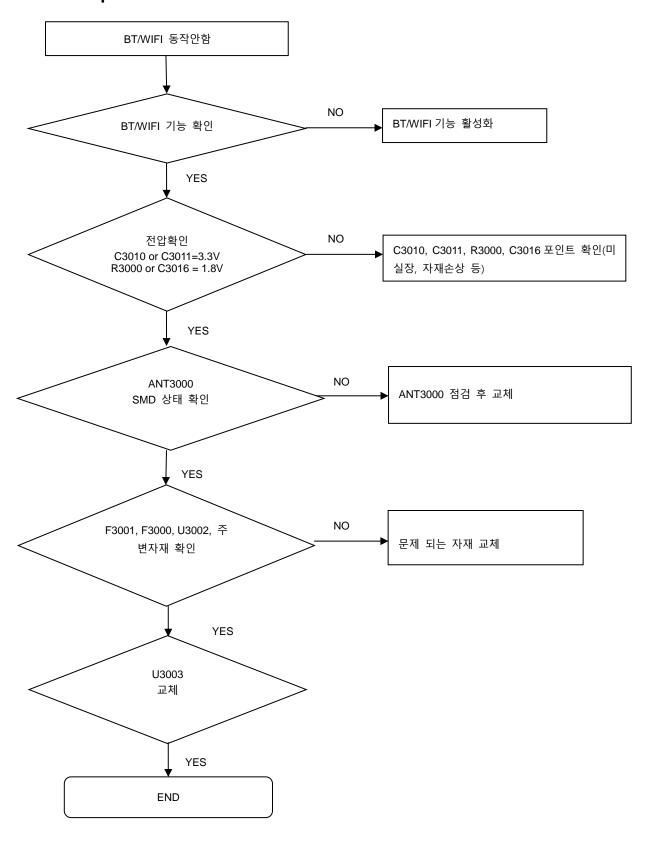
8-4-13. Earjack Part - Rx



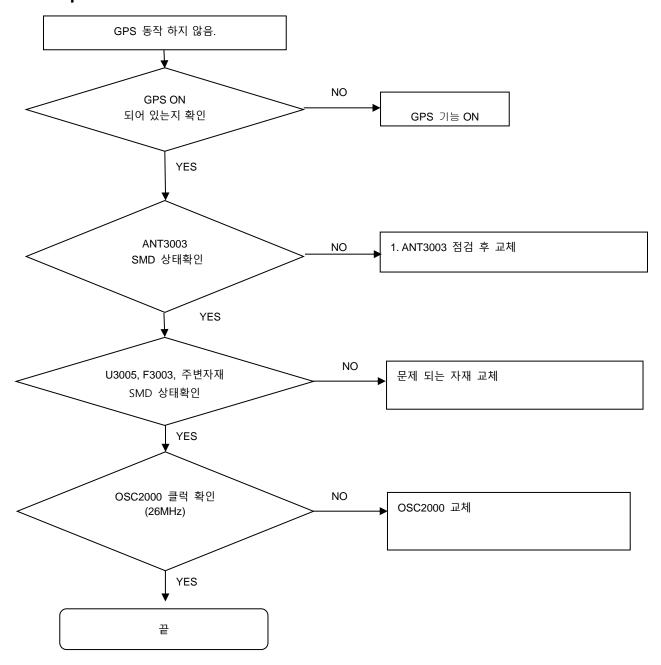
8-4-14. Earjack Part - Tx



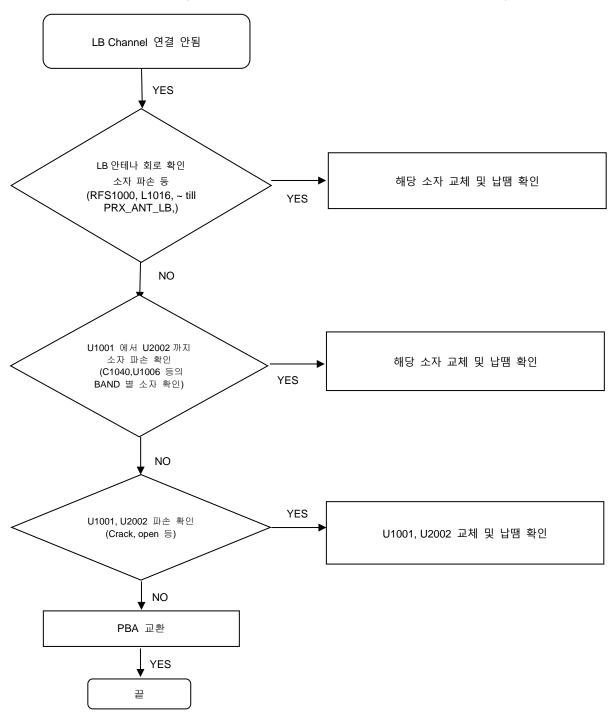
8-4-15. BT/WIFI part



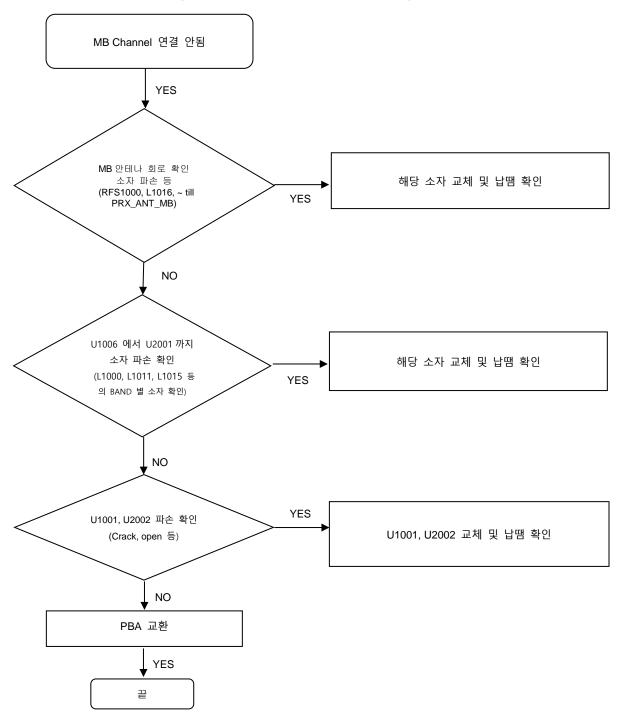
8-4-16. GPS part



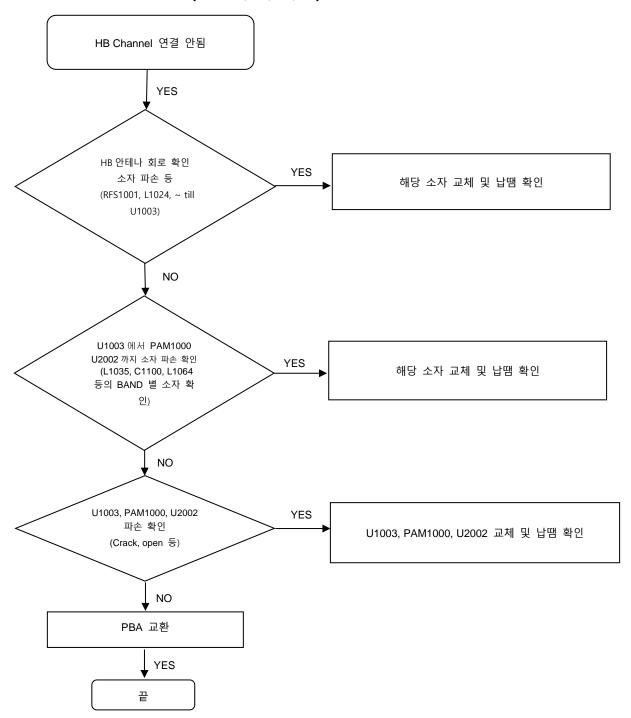
8-4-17. LOW BAND RX (GSM850, 900, W5, 8 LTE5, 8, 17, 20, 28)



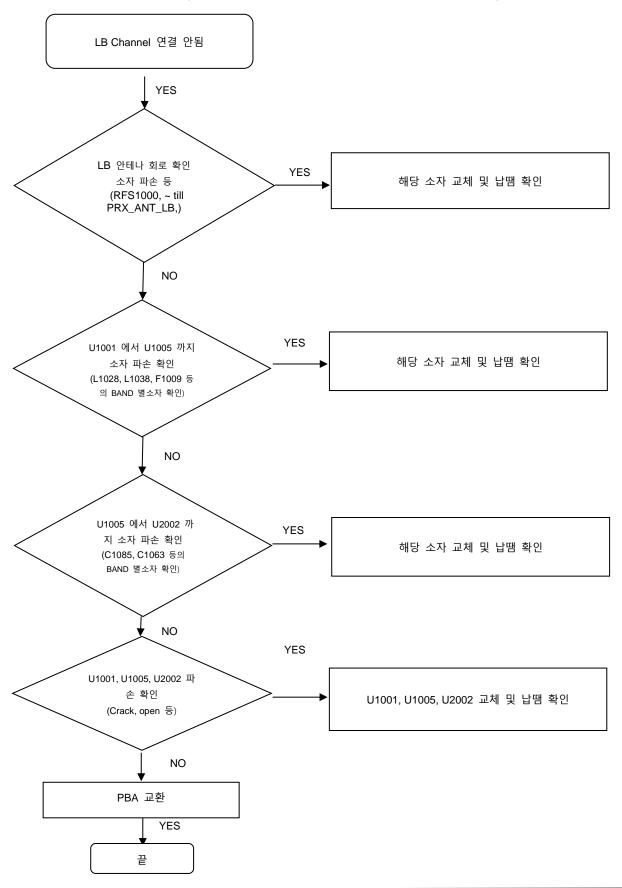
8-4-18. MID BAND RX (DCS, PCS, W1, W2, LTE 1,3)



8-4-19. HIGH BAND RX (LTE 7,38,40,41)

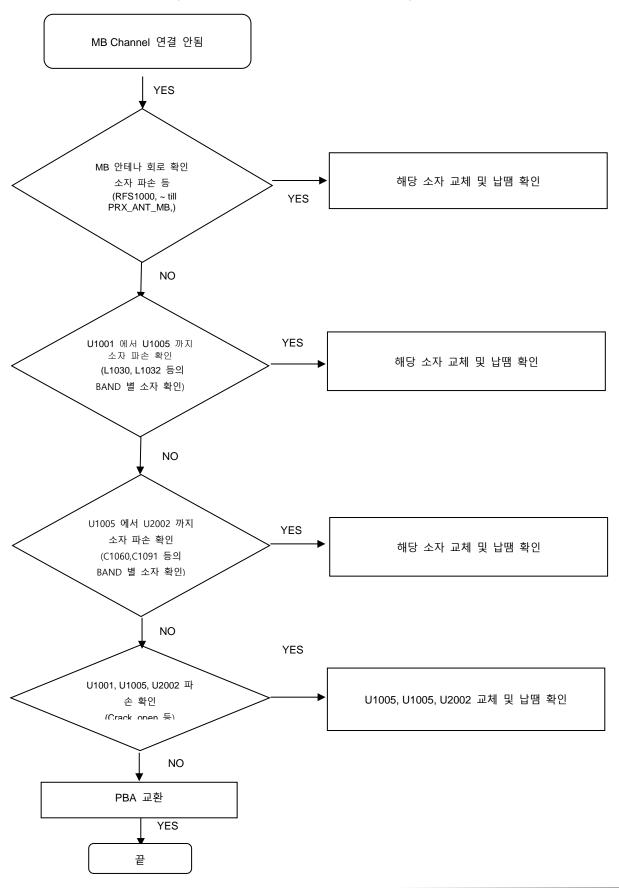


8-4-20. LOW BAND TX (GSM850,900, W5,8 LTE5, 8, 17, 20, 28)



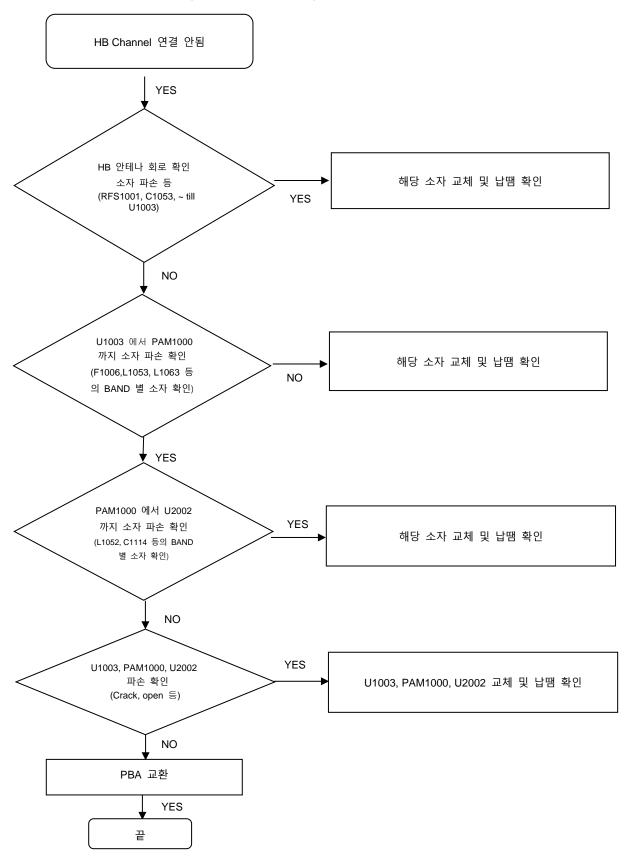
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8-4-21. MID BAND TX (DCS, PCS, W1, W2, LTE 1, 3)



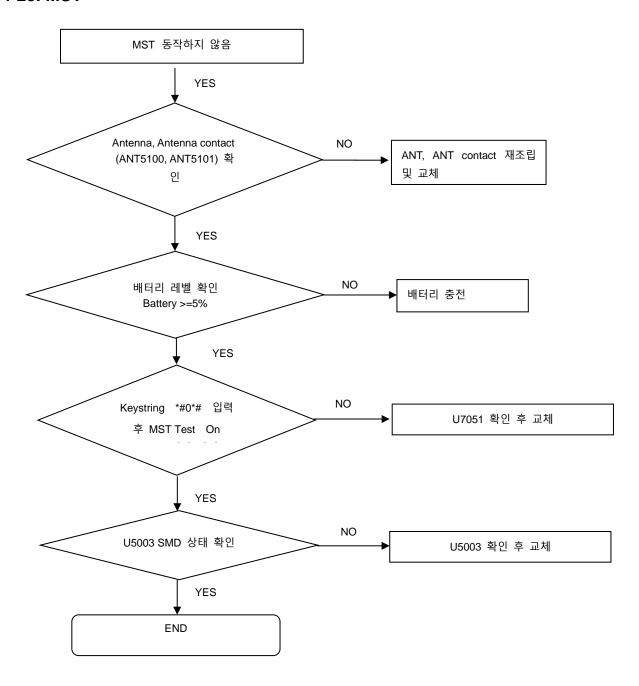
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8-4-22. HIGH BAND TX (LTE 7,38,40,41)



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8-4-23. MST



8-4-24. TDMB

